SUPPLIER

**URL** for Additional Information

EU RoHS Exemption(s)

 PART INFORMATION

 Mfg Item Number
 LS1020ASE8KQB

 Mfg Item Name
 FCPBGA 525 19\*19\*2.46

Company Name

Company Unique ID

Response Date

Freescale Semiconductor Inc

14-141-7928

2017-06-21

Response Date Response Document ID 00SDK50008S388M1.0 Contact Name Freescale Semiconductor Inc Contact Title Product Technical Support **Contact Phone** 1-800-521-6274 Contact Email support@freescale.com **Authorized Representative** Daniel Binyon Representative Title **EPP Customer Response** Representative Phone 512-895-3406 Representative Email eppanlst@freescale.com

DECLARATIONEU RoHSYesPb FreeYesHalogenFreeYesPlating Indicatore1

www.freescale.com

MANUFACTURING Mfg Item Number LS1020ASE8KQB FCPBGA 525 19\*19\*2.46 Mfg Item Name Version ALL Weight 2.577100 UoM Unit Volume EACH J-STD-020 MSL Rating 3 Peak Processing Temperature 250 C Max Time at Peak Temperature 30 seconds Number of Processing Cycles 3

RoHS	
RoHS Directive	2011/65/EU
RoHS Definition	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material of Cadmium
RoHS Legal Definition	Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part(s) identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a RoHS restricted substance) in excess of the applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Suppliers liability and the Companys remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Suppliers Standard Terms and Co
RoHS Declaration	1 - Item(s) do not contain RoHS restricted substances per the definition above
Supplier Acceptance	Accepted
Signature	Daniel Binyon
Exemption List Version	2012/51/EU
List of Freescale Accepted Exemptions	6(a) : Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0.35% lead by weight
Exemptions	6(b): Lead as an alloying element in aluminium containing up to 0.4% lead by weight
	6(c): Copper alloy containing up to 4% lead by weight
	7(a): Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead)
	7(b): Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signaling, transmission, and network management for telecommunications
	7(c)-I : Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound
	7(c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher
	7(c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC
	7(c)-IV: Lead in PZT based dielectric ceramic materials for capacitors being part of integrated circuits or discrete semiconductors
	15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit flip chip packages

Description	Homogeneous Material	Weight	SubstanceClass	Substance	CAS	Exemption	SubstanceWeight	UoM	SubPart PPM	SubPart%	ARTICLEPPM	ARTICLE%
Descript Again   Claim   Claim   Silver, confidence on the materials   Silver, confidence on the materials	Bonding Agent	0.0957						g				
Section   Sect	Bonding Agent		Solvents, additives, and other materials	Siloxanes and silicones, di-Me, vinyl group-terminated	68083-19-2		0.043065	g	450000	45	16710	1.671
Solic Flash - Leaf Free   0,1003   Solic Flash - Leaf Free   1	Bonding Agent		Glass	Silica, crystalline - quartz (SiO2)	14808-60-7		0.03828	g	400000	40	14853	1.4853
Description   Lead free   Le	Bonding Agent		Solvents, additives, and other materials	Dimethylvinylated and trimethylated silica	68988-89-6		0.014355	g	150000	15	5570	0.557
Solite files   Lead Fine   Means   Means   See, regil	Solder Balls - Lead Free	0.1303						g				
Solit Plane   Metals	Solder Balls - Lead Free		Metals	Copper, metal	7440-50-8		0.00065267	g	5009	0.5009	253	0.0253
De Encapaulant, Filter   Comment	Solder Balls - Lead Free		Metals	Silver, metal	7440-22-4		0.00391604	g	30054	3.0054	1519	0.1519
De Encapariant, Filier   Southern, addrives, and other materials   Aumirum, metal   74299.5   0.00744   1 72000   72   1462   0.1402	Solder Balls - Lead Free		Metals	Tin, metal	7440-31-5		0.12573129	g	964937	96.4937	48787	4.8787
De Encapalute, Filer   Soveres, addives, and other materials   Poportary Material-Other allocanes and silcones   Companier, Filer   Companier, F	Die Encapsulant, Filler	0.0052						g				
De Encapoulunt, Filer   Solvents, addivers, and other materials   Proprietary Material-Other miscellaneous substances   -   0.000502   g   1000   1   20   0.002   1   1   20   0.002   1   1   20   0.002   1   20   0.002   1   20   0.002   2   2   2   2   2   2   2   2   2	Die Encapsulant, Filler		Metals	Aluminum, metal	7429-90-5		0.003744	g	720000	72	1452	0.1452
December   Company   Com	Die Encapsulant, Filler		Solvents, additives, and other materials	Proprietary Material-Other siloxanes and silicones	-		0.000468	g	90000	9	181	0.0181
Underfil   0.0085   No.   Bismut/Bismuth Compounds   Bismuth Historian   1086-44-1   0.000325   0.0000000000000000000000000000000000	Die Encapsulant, Filler		Metals	Zinc oxide	1314-13-2		0.000936	g	180000	18	363	0.0363
Underfil   Bismuth Compounds	Die Encapsulant, Filler		Solvents, additives, and other materials	Proprietary Material-Other miscellaneous substances.	-		0.000052	g	10000	1	20	0.002
Underfil   Bismuth Dismuth Compounds	Underfill	0.0065						g				
Underfil	Underfill		Bismuth/Bismuth Compounds	Bismuth nitrate	10361-44-1		0.0000325	g	5000	0.5	12	0.0012
Underfil   Plasticspolymers   Phenolic Polymer Resin, Epikote 155   9003-86-5   0.00065   9   100000   10   252   0.0252	Underfill		Bismuth/Bismuth Compounds	Bismuth trioxide	1304-76-3		0.0000325	g	5000	0.5	12	0.0012
Underfile   Solvents, additives, and other materials   Carbon Black   1333-86-4   0.0000325   9   5000   0.5   12   0.0012	Underfill		Plastics/polymers	1,6-Bis(2,3-epoxypropoxy) naphthalene	27610-48-6		0.000975	g	150000	15	378	0.0378
Underfill   Plastics/polymers	Underfill		Plastics/polymers	Phenolic Polymer Resin, Epikote 155	9003-36-5		0.00065	g	100000	10	252	0.0252
Concentrate    Conc	Underfill		Solvents, additives, and other materials	Carbon Black	1333-86-4		0.0000325	g	5000	0.5	12	0.0012
Underfill   Solvents, additives, and other materials   Proprietary Material-Other miscellaneous substances.   -	Underfill		Plastics/polymers	4,4'-lsopropylidenediphenol-1-chloro-2,3-epoxypropane concentrate	25068-38-6			g		3	75	0.0075
Underfill         Solvents, additives, and other materials         Proprietary Material-Other aliphatic amine compounds         -         0.00065         g         100000         10         252         0.252           Organic Substrate, Halogen-fre         0.7716         Metals         Barium sulfate         7727-43-7         0.0063086         g         8176         0.8176         2447         0.2447           Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.27081617         g         350980         35.098         105085         105085         10.5085           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.12149691         g         157461         15.7461         47144         4.7144           Organic Substrate, Halogen-fre         Plastics/polymers         Other Epoxy resins         -         0.04908225         g         63611         6.3611         19045         1.9045         1.9045           Organic Substrate, Halogen-fre         Metals         Talc         14807-96-8         0.00127314         g         1650         0.165         494         0.0494           Organic Substrate, Halogen-fre         Solvents, additives, and other materials         Other organic phosphorous compounds         -	Underfill		Glass	Silica, vitreous	60676-86-0		0.0039	g	600000	60	1513	0.1513
Organic Substrate, Halogen-fre         0.7716         Metals         Barium sulfate         7727-43-7         0.0063086         g         8176         0.8176         2447         0.2447           Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.27081617         g         350980         35.098         105085         10.5085           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.12149691         g         157461         15.7461         47144         4.7144           Organic Substrate, Halogen-fre         Plastics/polymers         Other Epoxy resins         -         0.04908225         g         63611         6.3611         19045         1,9045           Organic Substrate, Halogen-fre         Metals         Talc         14807-96-6         0.00127314         g         1650         0.165         494         0.0494           Organic Substrate, Halogen-fre         Solvents, additives, and other materials         Other organic phosphorous compounds         -         0.00999145         g         12949         1.2949         3877         0.3877           Organic Substrate, Halogen-fre         Plastics/polymers         4,4*1-sporpopylidenediphenol-1-chloro-2,3-epoxypropane         25068-38-6         0.0229667	Underfill		Solvents, additives, and other materials	Proprietary Material-Other miscellaneous substances.	-		0.0000325	g	5000	0.5	12	0.0012
Organic Substrate, Halogen-fre         Metals         Barium sulfate         7727-43-7         0.063086         g         8176         0.8176         2447         0.2447           Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.27081617         g         350980         35.098         105085         10.5085           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.12149691         g         157461         15.7461         47144         4.7144           Organic Substrate, Halogen-fre         Plastics/polymers         Other Epoxy resins         -         0.04908225         g         63611         6.3611         19045         1.9045           Organic Substrate, Halogen-fre         Metals         Talc         14807-96-6         0.00127314         g         1650         0.165         494         0.0494           Organic Substrate, Halogen-fre         Solvents, additives, and other materials         Other organic phosphorous compounds         -         0.00999145         g         12949         1.2949         3877         0.3877           Organic Substrate, Halogen-fre         Plastics/polymers         4,41-sporpopylidenediphenol-1-chloro-2,3-epoxypropane         25068-38-6         0.0229667         g	Underfill		Solvents, additives, and other materials	Proprietary Material-Other aliphatic amine compounds	-		0.00065	g	100000	10	252	0.0252
Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.27081617         g         350980         35.098         105085 <t< td=""><td>Organic Substrate, Halogen-fre</td><td>0.7716</td><td></td><td></td><td></td><td></td><td></td><td>g</td><td></td><td></td><td></td><td></td></t<>	Organic Substrate, Halogen-fre	0.7716						g				
Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.12149691         g         157461         15.7461         47144         4.7144           Organic Substrate, Halogen-fre         Plastics/polymers         Other Epoxy resins         -         0.04908225         g         63611         6.3611         19045         1.9045           Organic Substrate, Halogen-fre         Metals         Talc         14807-96-6         0.00127314         g         1650         0.165         494         0.0494           Organic Substrate, Halogen-fre         Solvents, additives, and other materials         Other organic phosphorous compounds         -         0.00999145         g         12949         1.2949         3877         0.3877           Organic Substrate, Halogen-fre         Plastics/polymers         4,4*Isopropylidenediphenol-1-chloro-2,3-epoxypropane concentrate         25068-38-6         0.02296667         g         29765         2.9765         8911         0.8911	Organic Substrate, Halogen-fre		Metals	Barium sulfate	7727-43-7		0.0063086	g	8176	0.8176	2447	0.2447
Organic Substrate, Halogen-fre         Plastics/polymers         Other Epoxy resins         -         0.04908225         g         63611         63611         19045         1,9045           Organic Substrate, Halogen-fre         Metals         Talc         14807-96-6         0.00127314         g         1650         0.165         494         0.0494           Organic Substrate, Halogen-fre         Solvents, additives, and other materials         Other organic phosphorous compounds         -         0.00999145         g         12949         1.2949         3677         0.3877           Organic Substrate, Halogen-fre         Plastics/polymers         4,4*-Isopropylidenediphenol-1-chloro-2,3-epoxypropane concentrate         25068-38-6         0.02296667         g         29765         2.9765         8911         0.8911	Organic Substrate, Halogen-fre		Metals	Copper, metal	7440-50-8		0.27081617	g				10.5085
Organic Substrate, Halogen-fre         Metals         Talc         14807-96-6         0.00127314         g         1650         0.165         494         0.0494           Organic Substrate, Halogen-fre         Solvents, additives, and other materials         Other organic phosphorous compounds         -         0.00999145         g         12949         1.2949         3877         0.3877           Organic Substrate, Halogen-fre         Plastics/polymers         4,4*-Isopropylidenediphenol-1-chloro-2,3-epoxypropane concentrate         25068-38-6         0.02296667         g         29765         2.9765         8911         0.8911	Organic Substrate, Halogen-fre		Plastics/polymers	Epikote 862	28064-14-4		0.12149691	g	157461	15.7461	47144	4.7144
Organic Substrate, Halogen-fre     Solvents, additives, and other materials     Other organic phosphorous compounds     -     0.00999145     g     12949     1.2949     3877     0.3877       Organic Substrate, Halogen-fre     Plastics/polymers     4,4*-Isopropylidenediphenol-1-chloro-2,3-epoxypropane concentrate     25068-38-6     0.02296667     g     29765     2.9765     8911     0.8911	Organic Substrate, Halogen-fre		Plastics/polymers		-		0.04908225	g			19045	1.9045
Organic Substrate, Halogen-fre Plastics/polymers 4,4'-Isopropylidenediphenol-1-chloro-2,3-epoxypropane 25068-38-6 0.02296667 g 29765 2.9765 8911 0.8911	Organic Substrate, Halogen-fre		Metals	Talc	14807-96-6		0.00127314	g				0.0494
concentrate	Organic Substrate, Halogen-fre		Solvents, additives, and other materials	Other organic phosphorous compounds	-		0.00999145	g				0.3877
Organic Substrate Halogen-fre - 0.0080501 g 10/33 1.0433 1.0433 1.0433 1.0433 1.0433	Organic Substrate, Halogen-fre		Plastics/polymers	4,4'-lsopropylidenediphenol-1-chloro-2,3-epoxypropane concentrate	25068-38-6		0.02296667	g			8911	0.8911
	Organic Substrate, Halogen-fre		Plastics/polymers	Other polymers	-		0.0080501	g	10433	1.0433	3123	0.3123
	Organic Substrate, Halogen-fre			Fibrous-glass-wool	65997-17-3		0.11999692	g	155517		46562	4.6562
Organic Substrate, Halogen-fre         Glass         Silicon dioxide         7631-86-9         0.10039133         g         130108         13.0108         38955         3.8955	Organic Substrate, Halogen-fre							g			38955	
Organic Substrate, Halogen-fre         Metals         Silver, metal         7440-22-4         0.0000787         g         102         0.0102         30         0.003	Organic Substrate, Halogen-fre							g			30	
Organic Substrate, Halogen-fre         Metals         Tin, metal         7440-31-5         0.00252699         g         3275         0.3275         980         0.098	Organic Substrate, Halogen-fre		Metals	Tin, metal				g			000	
	Organic Substrate, Halogen-fre		Metals	Aluminum Hydroxide				g	75894		22723	2.2723
	Organic Substrate, Halogen-fre		Metals	Copper phthalocyanine	147-14-8		0.00006096	g	79	0.0079	23	0.0023
Pb-free Bumped Semiconductor D         0.0554         g	·	0.0554						g				
								g		0.0	101	0.0107
Pb-free Bumped Semiconductor D Metals Silver, metal 7440-22-4 0.00017451 g 3150 0.315 67 0.0067	·							g			•-	
Pb-free Bumped Semiconductor D         Metals         Tin, metal         7440-31-5         0.00481149         g         86850         8.685         1867         0.1867					7440-31-5			g				
			Solvents, additives, and other materials	Other miscellaneous substances (less than 5%).	•			g				0.0193
	Pb-free Bumped Semiconductor D		Glass	Silicon, doped	-		0.0496384	g	896000	89.6	19261	1.9261
Heat Spreader         1.5124         g	Heat Spreader	1.5124						g				
Heat Spreader         Metals         Copper, metal         7440-50-8         1.43687377         g         950062         95.0062         55754         55.7574	Heat Spreader		Metals	Copper, metal	7440-50-8		1.43687377	g	950062	95.0062	557574	55.7574
Heat Spreader         Nickel (external applications only)         Nickel         7440-02-0         0.07552623         g         49938         4.9938         29306         2.9306	Heat Spreader		Nickel (external applications only)	Nickel	7440-02-0		0.07552623	g	49938	4.9938	29306	2.9306

LINKS MCD LINK NXP website http://www.nxp.com GENERAL ENVIRONMENTAL COMPLIANCE LINKS http://www.nxp.com/files/corporate/doc/support\_info/NXP-ROHS-DECLARATION.pdf RoHS signed letter China RoHS http://www.nxp.com/about/corporate-responsibility/environmental-compliance-organization/china-rohs:ENV\_CHINA\_ROHS\_STRATEGY http://www.nxp.com/files/corporate/doc/support\_info/NXP-REACH-STATEMENT.pdf REACH signed letter http://www.nxp.com/files/corporate/doc/support\_info/NXP-ELV-STATEMENT.pdf ELV signed letter http://www.nxp.com/files/corporate/doc/support\_info/NXP-STATEMENT-CONFLICT-MINERALS.pdf Conflict Minerals statement NXP ENVIRONMENTAL INFORMATION Environmental Compliance website http://www.nxp.com/about/corporate-responsibility/environmental-compliance-organization:ABUENVPRFPRDX FAQ http://www.nxp.com/about/corporate-responsibility/environmental-compliance-organization/eco-product-faqs:ENVIRON\_FAQ http://www.nxp.com/support/sales-and-support:SUPPORTHOME Technical Service Request

http://www.NXP.com/files/abstract/corporate/ehs\_epp/IPC-1752-2\_v1.1\_MCD\_Template.pdf

LINKS TO BLANK IPC1752 FORMS Blank IPC1752 v1.1 Form

## IPC1752 XML LINKS

http://www.freescale.com/mcds/LS1020ASE8KQB\_IPC1752\_v11.xml

http://www.freescale.com/mcds/LS1020ASE8KQB\_IPC1752A.xml